



Akıllı Kontrolde Teknoloji Devi

MP110

HARDWARE MANUAL

- MP110
PLC Series

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MIKRODEV_HM_MP110_EN
V1.1

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Preface



Mikrodev MP201 and MP110 PLC series are programmable control devices that are used in a wide range of applications from process automation to building automation, from machine automation to telemetry applications.

In this document, you can find information about the hardware specifications of Mikrodev MP201/MP110 series PLCs.

Please follow our website www.mikrodev.com for the up to date version of the document.

About Mikrodev



Since 2006, MIKRODEV has been developing and manufacturing industrial control and communication products. MIKRODEV serves the system integrators in the public and private sector, OEM and end users.

Our products are manufactured complying with the quality standards required by the industrial automation industry and the quality of our products are proved on the field for many years

MIKRODEV is one of the few companies in the world that has its own designed IEC 61131-3 compliant library for its programmable logic control devices. In addition, the open, flexible, programmable SCADA solution developed by MIKRODEV is also available to customers.

MIKRODEV products' performance and wide range of applications make them possible for customers to achieve faster, simplified and cost-effective results.

WARNING!

- ✓ Please take care of the following issues when using Mikrodev devices.
- ✓ Since the unit operates with 24 VDC (12-36 VDC) voltage, you should take care of the voltage level that the unit is connected to. If a voltage above this voltage level is applied, the device may be damaged and may be out of warranty.
- ✓ Make sure that the energy connection of your device is connected to the ground or to a properly grounded terminal.
- ✓ Make sure that the environment in which your device is being used is free of moisture, electric shock, vibration and dust.
- ✓ Pay attention to the supply voltage and the connections of the product. Mikrodev is not responsible for any issues due to power failure since there is no auxiliary supply (UPS) on the device.
- ✓ The fuse to be used must be a FF super fast type and current limit value 1A.
- ✓ Do not use the device under conditions other than the environmental conditions specified in the "Electrical Specifications" section (humidity, dust, liquid and temperature, etc.)
- ✓ Removing the warranty label on the product or removing the protective case will void the warranty.
- ✓ Products that are damaged, boxes have been changed and other brand labels are affixed are not covered by the warranty.
- ✓ The appliance must not be cleaned with solvents (thinner, benzine, acid etc.) or with abrasive cleaning agents.
- ✓ Only dry cloth should be used when cleaning the appliance.
- ✓ Do not open the device by removing the case of the appliance, do not interfere with the electronic components and circuits. There is no user-replaceable part inside the device.
- ✓ If there is a problem or malfunction on your device, it should only be repaired by an authorized service. Installation and electrical connections must be made by technical personnel in accordance with the instructions in the operating manual.

Failure to comply with these rules may result in death, serious injury or property damage

1 MP110 GENERAL INFORMATION

1.1 Physical Interfaces

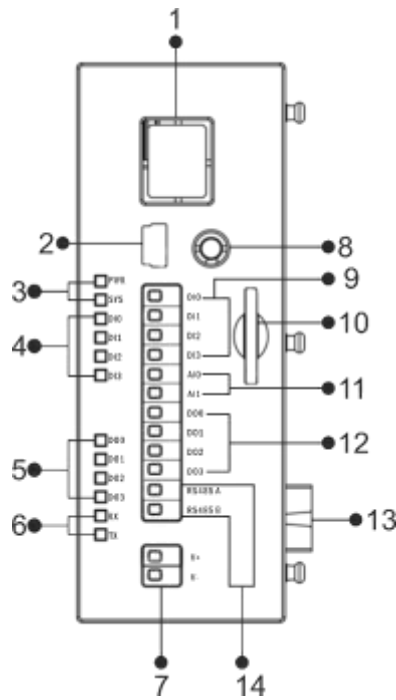


Figure 1 Connector and Physical Interfaces

1	Ethernet Port	8	Antenna Connection
2	USB Port	9	Digital Input Connections
3	System Power /Running LED	10	SIM Card Slot
4	Digital Input Status Information	11	Analog Input Connections
5	Digital Output Status Information	12	Digital Output Connections
6	Protocol Data Transfer LED	13	Expansion Connector
7	Device Power (V+/V-) Connection	14	RS485 Connections

1.2 General Device Specifications

SPECIFICATION	ITEM	DESCRIPTION
Processor	Processor Architecture	ARM Cortex M4
	Precossror Internal RAM	196 KB
	CPU Processing Speed	168 MHz
	Adressing Architecture	Little Endian Addressing
Electrical	Supply	24 VDC (12-36VDC)
	Power	<10W
	Real Time Clock	Integrated
Input / Output	Digital Input	4
	Digital Output	4
	Analog Input	2
Enviromental Conditions	Operating Temperature	-20 / +60 C
	Storage Temperature	-40 / +85 C
	Humidity	5..95 RH
Memory	Retentive Memory	4KB
	Program Memory	4MBit
Communication Ports	Ethernet Port*	100 Mbit, MODBUS TCP
	RS485	1
Wireless Communication	GSM / GPRS*	Quad-Band 850/900/1800/1900 MHz
Extension Capacity	RAIL Type- CANBUS Extension	Max. 128 Digital IO (64 DI, 64 DO) Max. 48 Analog IO (16 AI, 16 RTD Input, 16 AQ)

**May differ on some models*

2 INSTALLATION INFORMATION

2.1 Rail Installation

DIN Rail Mountage

First, the upper part of the device is mounted on the DIN rail. Then, with the help of the springs behind the device, when a lightly force is applied to the lower part, the device locates into the DIN rail easily and the montage is completed. (See 36 A - 36 B)

DIN Rail Demontage

To demount the device, firstly it is pulled from the bottom using flexibility of the spring, the device is removed from the DIN Rail and the demounting is completed.

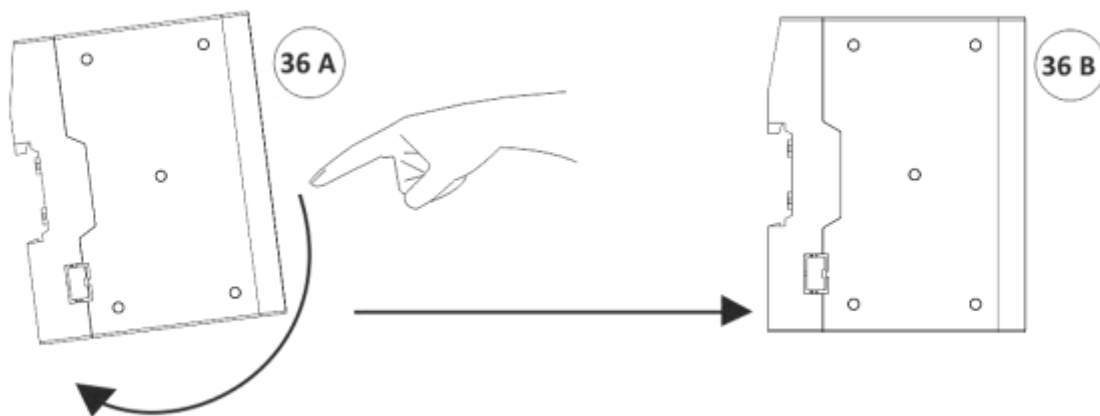


Figure 2 Mounting

2.2 Extension Installation

The MP110 product and its extensions are mounted by sliding over the rail in such a way that the connectors corresponds.

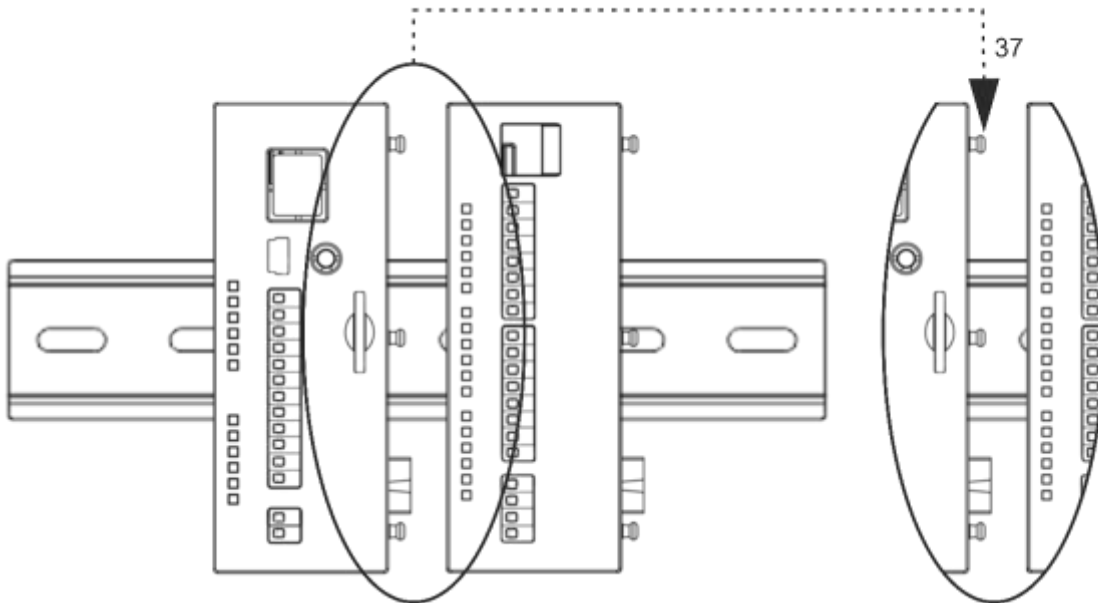


Figure 3 Extension Installation

3 CONNECTION DIAGRAMS

3.1 Supply Connection

Supply:	12-36 VDC, Protected
Power:	< 13 W

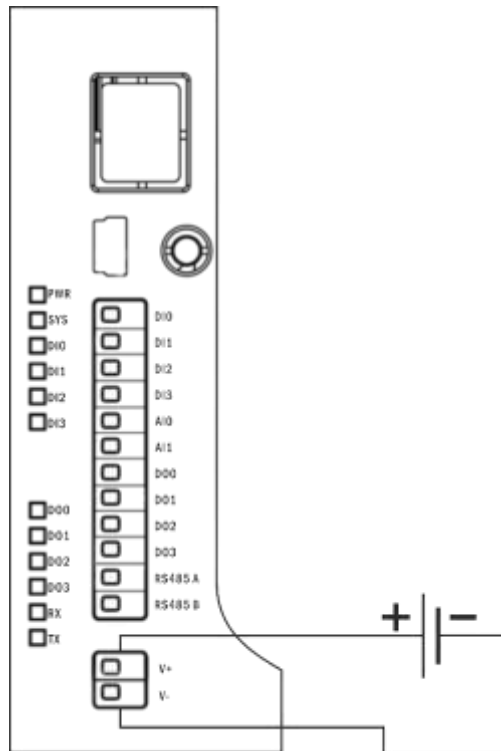


Figure 4 Power Connection Diagram

3.2 Digital Inputs

Module Input:	16 (Sink)
Voltage Range:	0-30 VDC
ON Voltage Level:	7 VDC -30 VDC
OFF Voltage Level:	0-4 VDC
Input Impedance:	>2M
Isolation:	Optical
OFF to ON Response:	20 us
ON to OFF Response:	90 us
Fast Counter Inputs:	DI1, DI2, DI3, DI4

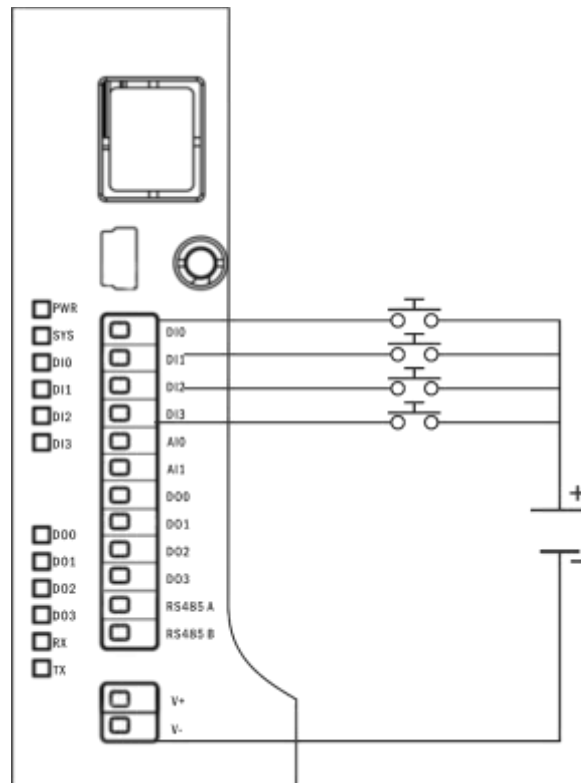


Figure 5 DIN Connection Diagram

3.3 Digital Outputs

Module Output:	Mosfet Output
Voltage Range:	0-40 VDC
Max. Output Current:	2 A/point (@30V)
Isolation:	Optical
External Voltage Input:	3.3-40 VDC
Fast Outputs PWM, PTO:	DQ1, DQ2, DQ3, DQ4
Fast Outputs Max. Frekans	20 kHz

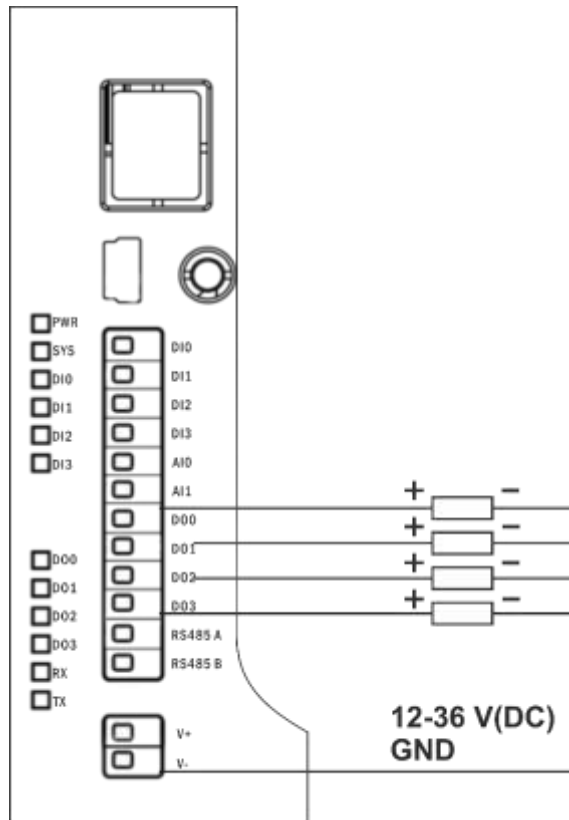


Figure 6 DOUT Connection Diagram

3.4 Analog Inputs

Current Input Count	2
Current Input Type	Current, 0-20 mA
Current Input Precision:	%1 Precision
Common Input GND:	1 (4 point / common)

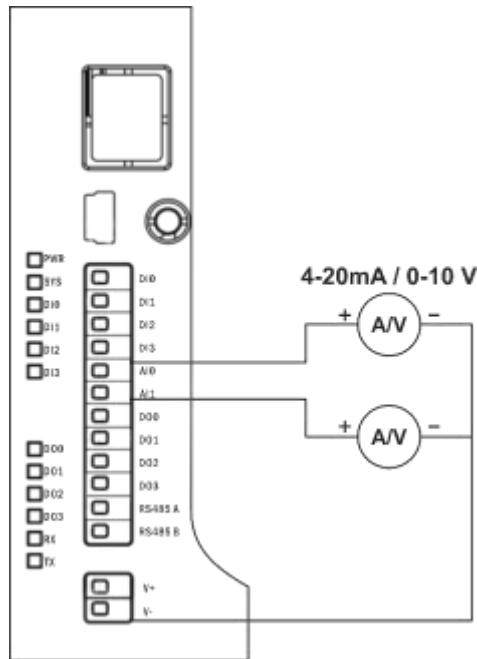


Figure 7 Analog Input Connection Diagram

3.5 RS485 SERIAL PORT

RS485 port Count:	1
Maximum Slave Counts:	200
Communication Distance:	1000 m
Data Bits:	7-8
Stop Bits:	1-2
Parity:	None-Even-Odd
Baudrate:	300 bps to 200 kbps

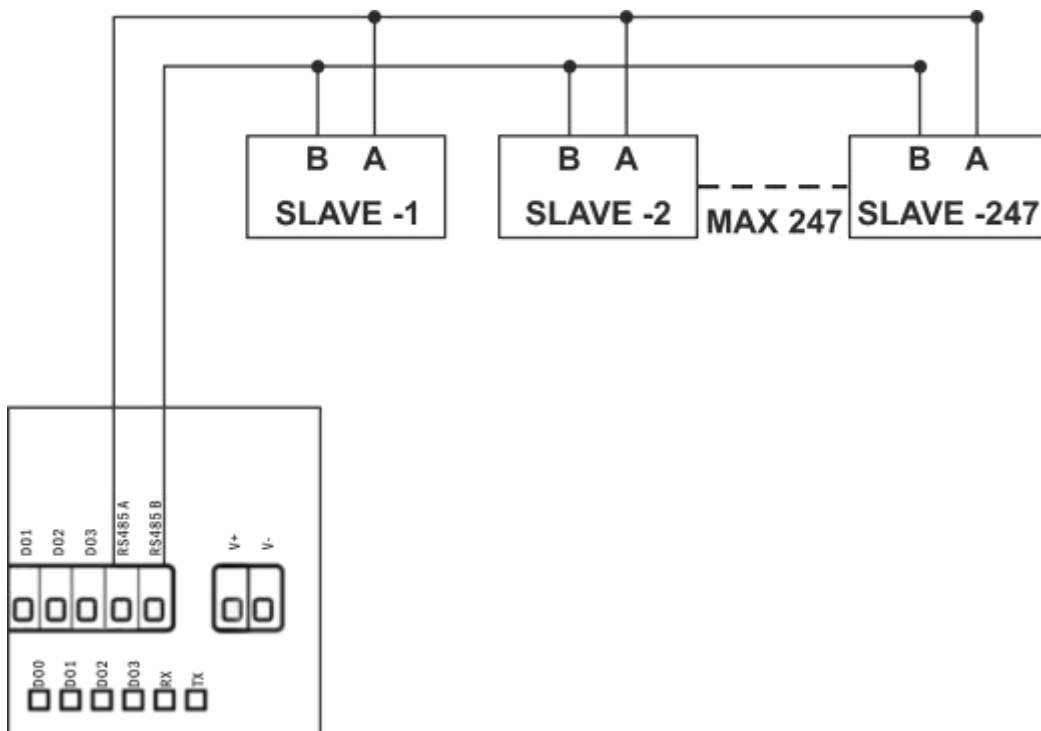


Figure 8 RS485 Input Connection Diagram